

Performance Curves MYA MYB MYC

See Pages 4-20, 21, 22

M106 M107 M108



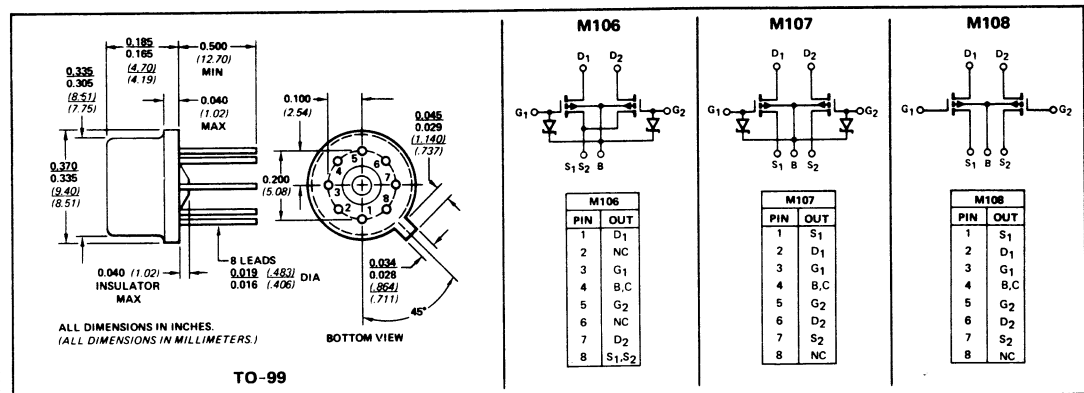
DUAL P-CHANNEL ENHANCEMENT-TYPE SILICON MOS FIELD-EFFECT TRANSISTORS

NORMALLY-OFF MOS FETS FOR ANALOG SWITCHES ELECTROMETERS AND AMPLIFIERS

- Common Sources on M106
- High Impedance M108
- Integrated Zener Clamps Protect Gates on M106, M107
- Low I_{GSS}

ABSOLUTE MAXIMUM RATINGS (25°C)

Drain-to-Source Voltage -30 V	Gate Zener Current ±1.0 mA
Gate-to-Source Voltage (M106/7) -30 V	Storage Temperature -65 to 150°C
Gate-to-Source Voltage (M108) -50 V	Operating Junction Temperature . . . -55 to 125°C
Gate-to-Drain Voltage (M106/7) -30 V	Total Dissipation at 25°C Ambient Temperature
Gate-to-Drain Voltage (M108) -50 V	(Derate 5 mW/°C to 125°C) 500 mW
Drain Current -50 mA	

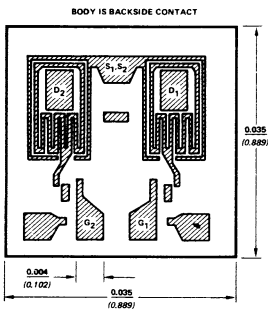


ELECTRICAL CHARACTERISTICS (25°C unless otherwise noted)

	Characteristic	M106, M107		M108		Unit	Test Conditions
		Min	Max	Min	Max		
S T A T E C	1 BV _{DSS} Drain-Source Breakdown Voltage	-30		-30		V	I _D = -1 μA, V _{GS} = V _{BS} = 0
	2 BV _{SDS} Source-Drain Breakdown Voltage	-30		-30			I _S = -1 μA, V _{GD} = V _{BD} = 0
	3 BV _{GBS} Gate-Body Breakdown Voltage	-30		±100*			I _G = -10 μA, V _{SB} = V _{DB} = 0
	4 I _{GSS} Gate-Body Leakage		-100		-1	pA	V _{GS} = -20 V, V _{DS} = V _{BS} = 0
	5 I _{D(off)} Drain Cutoff Current		-0.2		-0.2	nA	V _{DS} = -20 V, V _{GS} = V _{BS} = 0
	6 I _{S(off)} Source Cutoff Current		-0.2		-0.2	nA	V _{SD} = -20 V, V _{GD} = V _{BD} = 0
	7 V _{GS(th)} Gate Threshold Voltage	-2	-6	-2	-8	V	V _{GS} = V _{DS} , I _D = -10 μA, V _{BS} = 0
	8 I _{D(on)} Drain Current	-10		-10		mA	V _{DS} = -10 V, V _{GS} = -10 V, V _{BS} = 0
	9 r _{DS(on)} Drain Source ON Resistance		150		150	Ω	V _{GS} = -15 V, I _D = -100 μA, V _{BS} = 0
	10		120		120		V _{GS} = -20 V, I _D = -100 μA, V _{BS} = 0
D Y N A M I C	11 g _{fs} Common-Source Forward Transconductance	2,000		2,000		μmho	V _{DS} = -10 V, V _{GS} = -10 V, V _{BS} = 0 f = 1 kHz
	12 C _{gs} or C _{gd} Gate-Source or Gate-Drain Capacitance		4		4		V _{GB} = V _{DB} = 0, f = 1 MHz, Body Guarded
	13 C _{sb} or C _{db} Source-Body or Drain-Body Capacitance		5.5		5.5		V _{GB} = 0, V _{DB} = V _{SB} = -5 V, f = 1 MHz
	14 C _{ds} Drain-Source Capacitance		0.5		0.5		V _{GB} = 0, V _{DB} = V _{SB} = -5 V, f = 1 MHz, Body Guarded
*Gate-Oxide Breakdown Voltage		MYA (M106)	MYB (M107)	MYC (M108)			

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DUAL P-CHANNEL ENHANCEMENT-TYPE SILICON MOS FIELD-EFFECT TRANSISTOR



ALL DIMENSIONS IN INCHES
(ALL DIMENSIONS IN MILLIMETERS)

APPLICATIONS

- Operational Amplifiers
- Audio Amplifiers
- Commutating Circuits
- Multiplexer Circuits
- Analog Switches

FEATURES

- Common Sources
- Integrated Zener Clamp Protects the Gates
- Low I_{GSS}
- Normally OFF

PRINCIPAL DEVICE

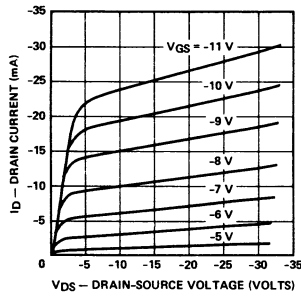
M106

PACKAGE TYPE

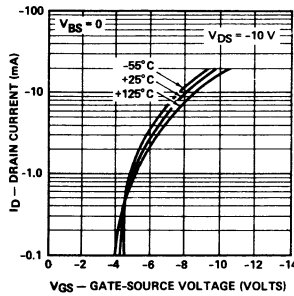
TO-99

PERFORMANCE CURVES (25°C and $V_{BS} = 0$ unless otherwise noted)

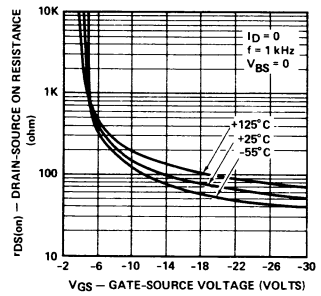
Output Characteristic



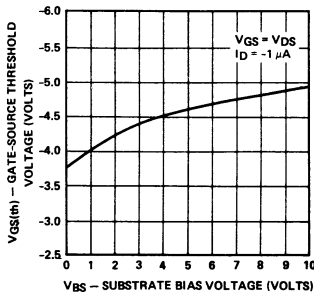
Transfer Characteristics



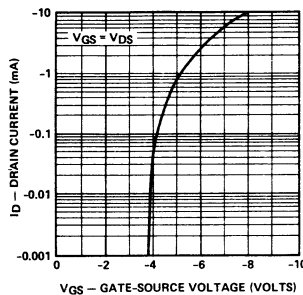
Drain-Source ON Resistance vs Gate-Source Bias



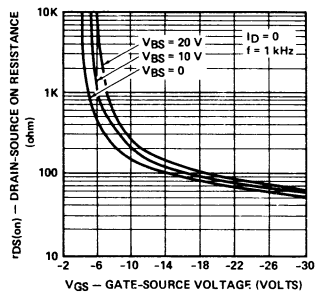
Gate Threshold Voltage vs Substrate Bias Voltage



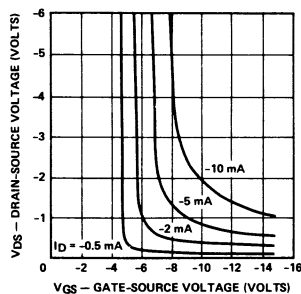
Gate-Source Voltage vs Drain Current



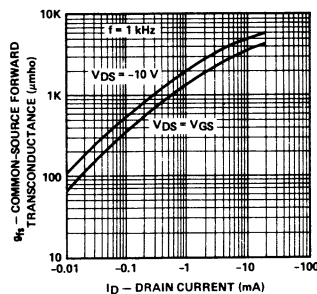
Drain-Source ON Resistance vs Gate-Source Bias

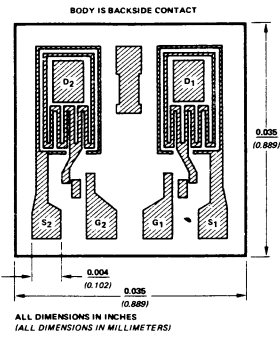


Low Level ON Drain-Source Voltage vs Gate-Source Bias



Transconductance Characteristics





DUAL P-CHANNEL ENHANCEMENT-TYPE SILICON MOS FIELD-EFFECT TRANSISTOR

APPLICATIONS

- Audio Amplifiers
- Operational Amplifiers
- Commutating Circuits
- Multiplexer Circuits
- Analog Switches

PRINCIPAL DEVICE

M107

PACKAGE TYPE

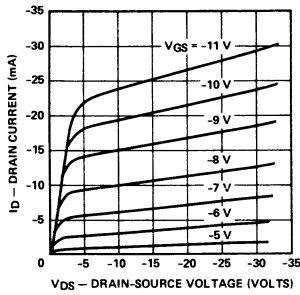
TO-99

FEATURES

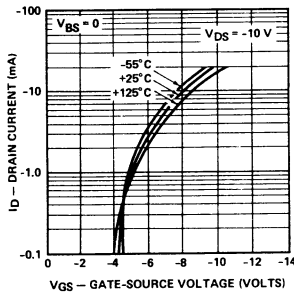
- Integrated Zener Clamp Protects the Gates
- Low I_{GSS}
- Normally OFF

PERFORMANCE CURVES (25°C and $V_{BS} = 0$ unless otherwise noted)

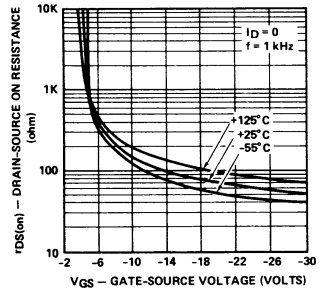
Output Characteristics



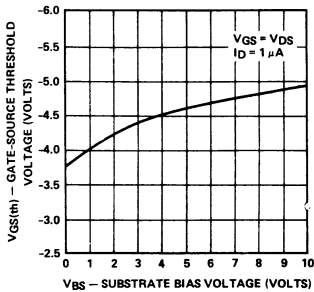
Transfer Characteristics



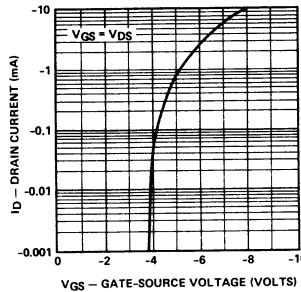
Drain-Source ON Resistance vs Gate-Source Bias



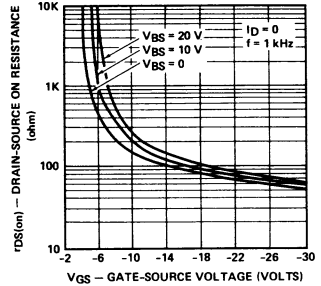
Gate Threshold Voltage vs Substrate Bias Voltage



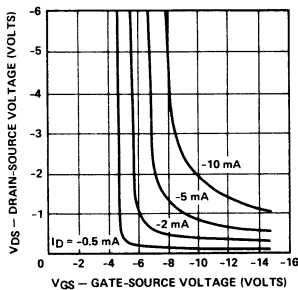
Gate-Source Voltage vs Drain Current



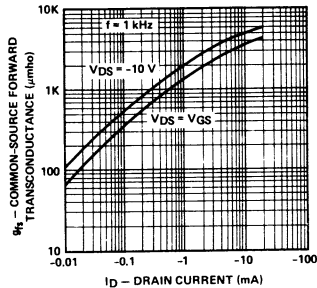
Drain-Source ON Resistance vs Gate-Source Bias



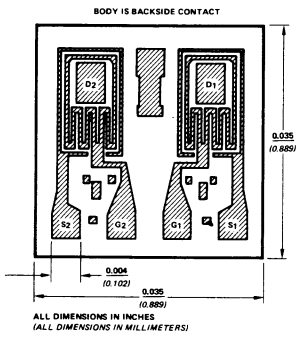
Low Level ON Drain-Source Voltage vs Gate-Source Bias



Transconductance Characteristics



DUAL P-CANNEL ENHANCEMENT-TYPE SILICON MOS FIELD EFFECT TRANSISTOR



APPLICATIONS

- Operational Amplifiers
- Audio Amplifiers
- Ultra-High Input Impedance Amplifiers for such Circuits as
 - Proximity Detectors
 - Smoke Detectors
 - pH Detectors
 - Transducer Amplifiers
 - Electrometers
- Commutating Circuits
- Multiplexer Circuits
- Analog Switches

FEATURES

- No Gate Protection Which Results In Ultra-High Input Impedance
- Ultra-Low Leakage
- Normally OFF

PRINCIPAL DEVICE

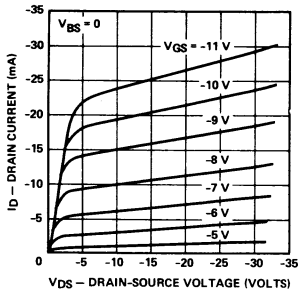
M108

PACKAGE TYPE

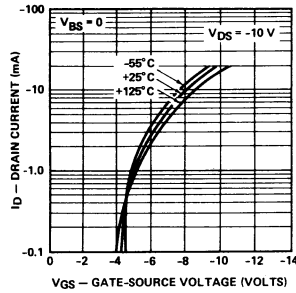
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PERFORMANCE CURVES (25°C unless otherwise noted)

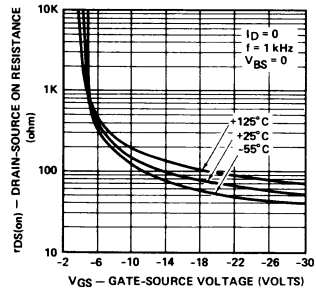
Transfer Characteristics



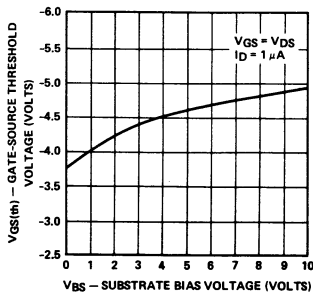
Transfer Characteristics



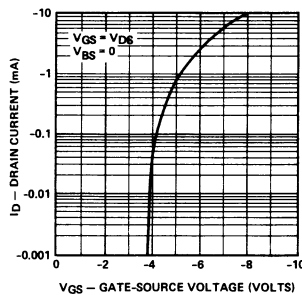
Drain-Source ON Resistance vs Gate-Source Bias



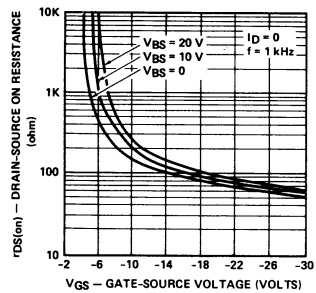
Gate-Source Voltage vs Substrate Bias



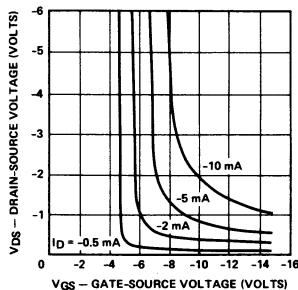
Gate-Source Voltage vs Drain Current



Drain-Source ON Resistance vs Gate-Source Bias



Low-Level ON Drain-Source Voltage vs Gate-Source Bias



Transconductance Characteristics

